

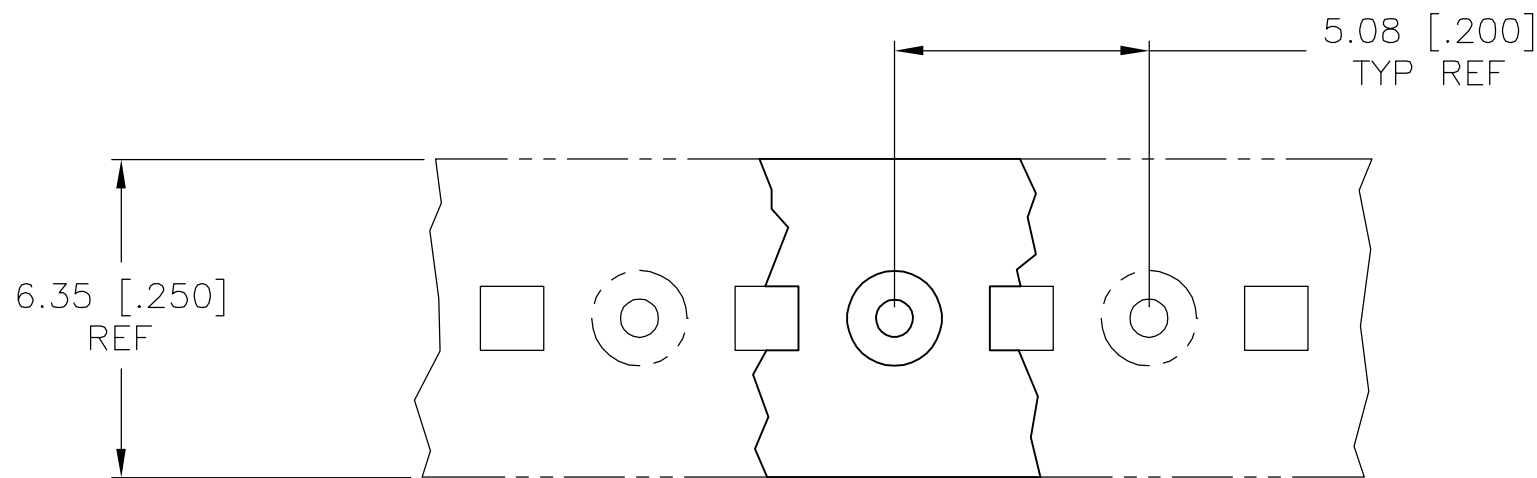
THIS DRAWING IS UNPUBLISHED.

RELEASED FOR PUBLICATION

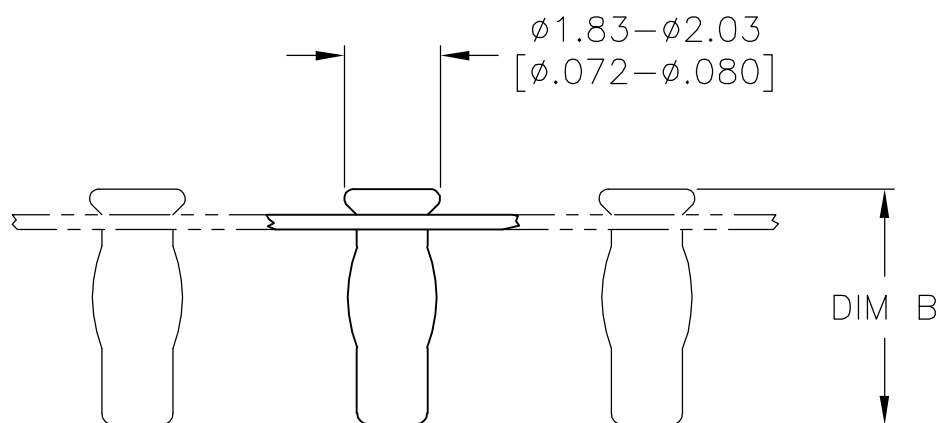
© COPYRIGHT - BY TYCO ELECTRONICS CORPORATION. ALL RIGHTS RESERVED.

LOC	DIST	REVISIONS					
		P	LTR	DESCRIPTION	DATE	DWN	APVD
AG	53		0	RELEASED	25JAN06	JDP	JGH

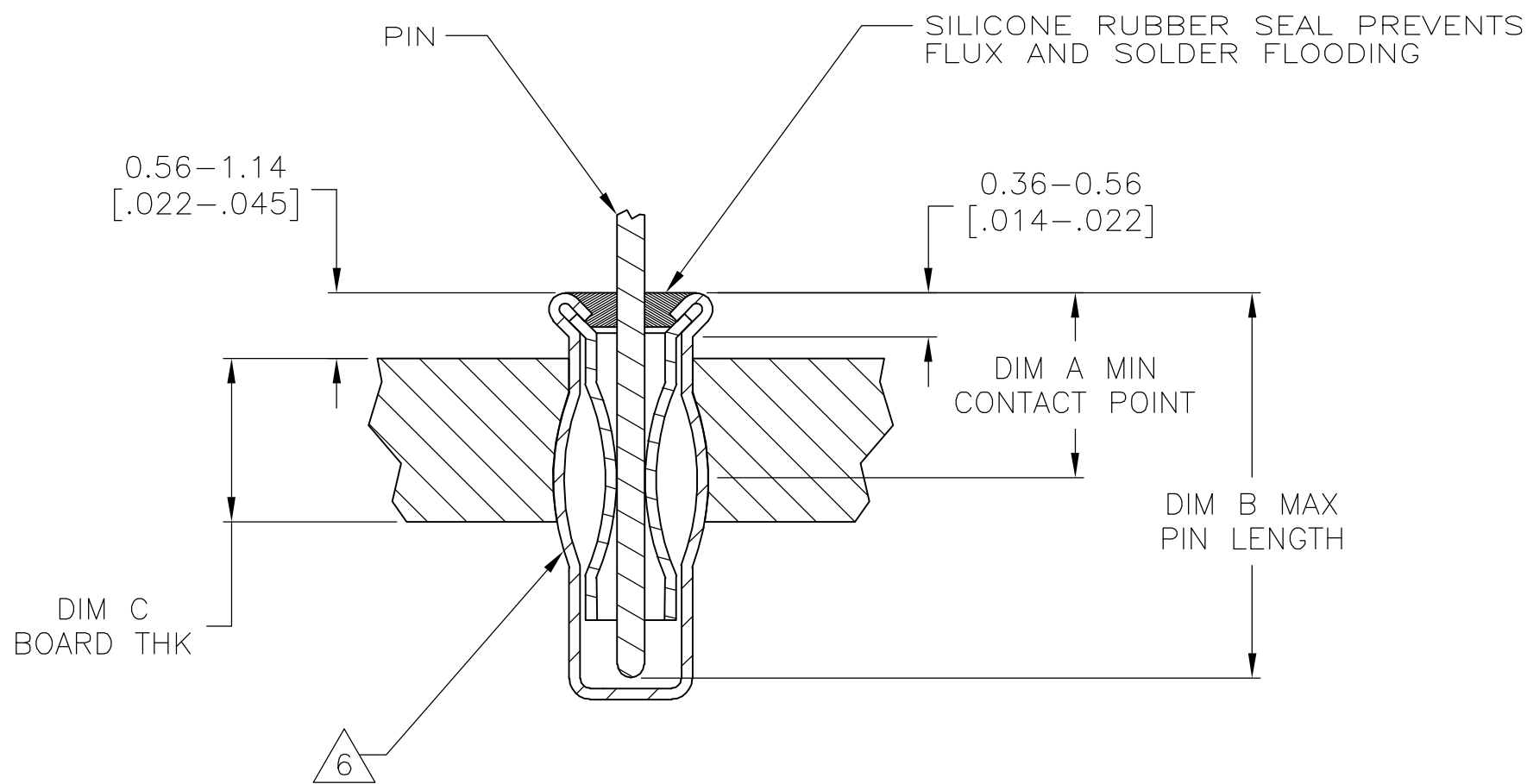
D



C



B



A

- 1 MATERIAL:
EYELET — COPPER PER ASTM B 152
SPRING — BERYLLIUM COPPER PER ASTM B 194
SEALANT — SILICONE RUBBER
- 2 TIN PLATE PER ASTM B 545, 0.00254 [.000100] MINIMUM THICKNESS.
- 3 GOLD PLATE PER ASTM B 488, 0.00076 [.000030] MIN THK ON CONTACT AREA.
- 4 PACKAGED, 10,000 PER REEL.
- 5 TO INSURE 1/2 OZ MIN RETENTION DO NOT EXCEED 0.05 [.002] DIFFERENCE IN PIN DIA WHEN CHANGING TO A SMALLER DIA PIN
- 6 PRODUCT IS OVALIZED FOR RETENTION IN THE P.C. BOARD. THE RECOMMENDED HOLE DIAMETER IS Ø1.57 [Ø.062] MINIMUM, +0.08 [.003] MAX. PRIOR TO SOLDERING.

D

C

5645994

B

A

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[TE Connectivity:](#)

[5645994-1](#)